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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	24MHz
Connectivity	UART/USART
Peripherals	WDT
Number of I/O	32
Program Memory Size	20KB (20K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/at89c55wd-24au">https://www.e-xfl.com/product-detail/microchip-technology/at89c55wd-24au</a>

## 4.6 Port 3

Port 3 is an 8-bit bi-directional I/O port with internal pull-ups. The Port 3 output buffers can sink/source four TTL inputs. When 1s are written to Port 3 pins, they are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 3 pins that are externally being pulled low will source current ( $I_{IL}$ ) because of the pull-ups.

Port 3 receives some control signals for Flash programming and verification.

Port 3 also serves the functions of various special features of the AT89C55WD, as shown in the following table.

Port Pin	Alternate Functions
P3.0	RXD (serial input port)
P3.1	TXD (serial output port)
P3.2	$\overline{\text{INT0}}$ (external interrupt 0)
P3.3	$\overline{\text{INT1}}$ (external interrupt 1)
P3.4	T0 (timer 0 external input)
P3.5	T1 (timer 1 external input)
P3.6	$\overline{\text{WR}}$ (external data memory write strobe)
P3.7	$\overline{\text{RD}}$ (external data memory read strobe)

## 4.7 RST

Reset input. A high on this pin for two machine cycles while the oscillator is running resets the device. This pin drives High for 98 oscillator periods after the Watchdog times out. The DISRTO bit in SFR AUXR (address 8EH) can be used to disable this feature. In the default state of bit DISRTO, the RESET HIGH out feature is enabled.

## 4.8 ALE/ $\overline{\text{PROG}}$

Address Latch Enable is an output pulse for latching the low byte of the address during accesses to external memory. This pin is also the program pulse input ( $\overline{\text{PROG}}$ ) during Flash programming.

In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency and may be used for external timing or clocking purposes. Note, however, that one ALE pulse is skipped during each access to external data memory.

If desired, ALE operation can be disabled by setting bit 0 of SFR location 8EH. With the bit set, ALE is active only during a MOVX or MOVC instruction. Otherwise, the pin is weakly pulled high. Setting the ALE-disable bit has no effect if the microcontroller is in external execution mode.

## 4.9 $\overline{\text{PSEN}}$

Program Store Enable is the read strobe to external program memory.

When the AT89C55WD is executing code from external program memory,  $\overline{\text{PSEN}}$  is activated twice each machine cycle, except that two  $\overline{\text{PSEN}}$  activations are skipped during each access to external data memory.

## 4.10 $\overline{EA}/VPP$

External Access Enable.  $\overline{EA}$  must be strapped to GND in order to enable the device to fetch code from external program memory locations starting at 0000H up to FFFFH. Note, however, that if lock bit 1 is programmed,  $\overline{EA}$  will be internally latched on reset.

$\overline{EA}$  should be strapped to  $V_{CC}$  for internal program executions.

This pin also receives the 12V programming enable voltage ( $V_{PP}$ ) during Flash programming.

## 4.11 XTAL1

Input to the inverting oscillator amplifier and input to the internal clock operating circuit.

## 4.12 XTAL2

Output from the inverting oscillator amplifier.

# 5. Special Function Registers

A map of the on-chip memory area called the Special Function Register (SFR) space is shown in Table 5-1.

**Table 5-1.** AT89C55WD SFR Map and Reset Values

0F8H								0FFH
0F0H	B 00000000							0F7H
0E8H								0EFH
0E0H	ACC 00000000							0E7H
0D8H								0DFH
0D0H	PSW 00000000							0D7H
0C8H	T2CON 00000000	T2MOD XXXXXX00	RCAP2L 00000000	RCAP2H 00000000	TL2 00000000	TH2 00000000		0CFH
0C0H								0C7H
0B8H	IP XX000000							0BFH
0B0H	P3 11111111							0B7H
0A8H	IE 0X000000							0AFH
0A0H	P2 11111111		AUXR1 XXXXXXX0				WDTRST XXXXXXXX	0A7H
98H	SCON 00000000	SBUF XXXXXXXX						9FH
90H	P1 11111111							97H
88H	TCON 00000000	TMOD 00000000	TL0 00000000	TL1 00000000	TH0 00000000	TH1 00000000	AUXR XXX00XX0	8FH
80H	P0 11111111	SP 00000111	DP0L 00000000	DP0H 00000000	DP1L 00000000	DP1H 00000000	PCON 0XXX0000	87H

Note that not all of the addresses are occupied, and unoccupied addresses may not be implemented on the chip. Read accesses to these addresses will in general return random data, and write accesses will have an indeterminate effect.

User software should not write 1s to these unlisted locations, since they may be used in future products to invoke new features. In that case, the reset or inactive values of the new bits will always be 0.

**Timer 2 Registers:** Control and status bits are contained in registers T2CON (shown in Table 5-2) and T2MOD (shown in Table 5-2) for Timer 2. The register pair (RCAP2H, RCAP2L) are the Capture/Reload registers for Timer 2 in 16-bit capture mode or 16-bit auto-reload mode.

**Interrupt Registers:** The individual interrupt enable bits are in the IE register. Two priorities can be set for each of the six interrupt sources in the IP register.

**Dual Data Pointer Registers:** To facilitate accessing both internal and external data memory, two banks of 16-bit Data Pointer Registers are provided: DP0 at SFR address locations 82H-83H and DP1 at 84H-85H. Bit DPS = 0 in SFR AUXR1 selects DP0 and DPS = 1 selects DP1. The user should always initialize the DPS bit to the appropriate value before accessing the respective Data Pointer Register.

**Power Off Flag:** The Power Off Flag (POF) is located at bit 4 (PCON.4) in the PCON SFR. POF is set to “1” during power up. It can be set and reset under software control and is not affected by reset.

**Table 5-2.** T2CON—Timer/Counter 2 Control Register

T2CON Address = 0C8H

Reset Value = 0000 0000B

Bit Addressable

Bit	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/ $\overline{T}2$	CP/ $\overline{RL}2$
	7	6	5	4	3	2	1	0

Symbol	Function
TF2	Timer 2 overflow flag set by a Timer 2 overflow and must be cleared by software. TF2 will not be set when either RCLK = 1 or TCLK = 1.
EXF2	Timer 2 external flag set when either a capture or reload is caused by a negative transition on T2EX and EXEN2 = 1. When Timer 2 interrupt is enabled, EXF2 = 1 will cause the CPU to vector to the Timer 2 interrupt routine. EXF2 must be cleared by software. EXF2 does not cause an interrupt in up/down counter mode (DCEN = 1).
RCLK	Receive clock enable. When set, causes the serial port to use Timer 2 overflow pulses for its receive clock in serial port Modes 1 and 3. RCLK = 0 causes Timer 1 overflow to be used for the receive clock.
TCLK	Transmit clock enable. When set, causes the serial port to use Timer 2 overflow pulses for its transmit clock in serial port Modes 1 and 3. TCLK = 0 causes Timer 1 overflows to be used for the transmit clock.
EXEN2	Timer 2 external enable. When set, allows a capture or reload to occur as a result of a negative transition on T2EX if Timer 2 is not being used to clock the serial port. EXEN2 = 0 causes Timer 2 to ignore events at T2EX.
TR2	Start/Stop control for Timer 2. TR2 = 1 starts the timer.
C/ $\overline{T}2$	Timer or counter select for Timer 2. C/ $\overline{T}2$ = 0 for timer function. C/ $\overline{T}2$ = 1 for external event counter (falling edge triggered).
CP/ $\overline{RL}2$	Capture/Reload select. CP/ $\overline{RL}2$ = 1 causes captures to occur on negative transitions at T2EX if EXEN2 = 1. CP/ $\overline{RL}2$ = 0 causes automatic reloads to occur when Timer 2 overflows or negative transitions occur at T2EX when EXEN2 = 1. When either RCLK or TCLK = 1, this bit is ignored and the timer is forced to auto-reload on Timer 2 overflow.

**Table 5-3. AUXR: Auxiliary Register**

AUXR

Address = 8EH

Reset Value = XXX00XX0B

Not Bit Addressable

	–	–	–	WDIDLE	DISRTO	–	–	DISALE
Bit	7	6	5	4	3	2	1	0

–

Reserved for future expansion

DISALE

Disable/Enable ALE

DISALE

Operating Mode

0

ALE is emitted at a constant rate of 1/6 the oscillator frequency

1

ALE is active only during a MOVX or MOVC instruction

DISRTO

Disable/Enable Reset out

DISRTO

Operating Mode

0

Reset pin is driven High after WDT times out

1

Reset pin is input only

WDIDLE

Disable/Enable WDT in IDLE mode

WDIDLE

Operating Mode

0

WDT continues to count in IDLE mode

1

WDT halts counting in IDLE mode

**Table 5-4. AUXR1: Auxiliary Register 1**

AUXR1	Address = A2H	Reset Value = XXXXXXX0B							
	Not Bit Addressable								
		–	–	–	–	–	–	DPS	
Bit		7	6	5	4	3	2	1	0
–	Reserved for future expansion								
DPS	Data Pointer Register Select								
	DPS								
0	Selects DPTR Registers DP0L, DP0H								
1	Selects DPTR Registers DP1L, DP1H								

## 6. Memory Organization

The MCS-51 devices have a separate address space for Program and Data Memory. Up to 64 Kbytes each of external Program and Data Memory can be addressed.

### 6.1 Program Memory

If the  $\overline{EA}$  pin is connected to GND, all program fetches are directed to external memory.

On the AT89C55WD, if  $\overline{EA}$  is connected to  $V_{CC}$ , program fetches to addresses 0000H through 4FFFH are directed to internal memory and fetches to addresses 5000H through FFFFH are to external memory.

### 6.2 Data Memory

The AT89C55WD implements 256 bytes of on-chip RAM. The upper 128 bytes occupy a parallel address space to the Special Function Registers. That means the upper 128 bytes have the same addresses as the SFR space but are physically separate from SFR space.

When an instruction accesses an internal location above address 7FH, the address mode used in the instruction specifies whether the CPU accesses the upper 128 bytes of RAM or the SFR space. Instructions that use direct addressing access SFR space.

For example, the following direct addressing instruction accesses the SFR at location 0A0H (which is P2).

```
MOV 0A0H, #data
```

Instructions that use indirect addressing access the upper 128 bytes of RAM. For example, the following indirect addressing instruction, where R0 contains 0A0H, accesses the data byte at address 0A0H, rather than P2 (whose address is 0A0H).

```
MOV @R0, #data
```

Note that stack operations are examples of indirect addressing, so the upper 128 bytes of data RAM are available as stack space.

## 7. Hardware Watchdog Timer (One-time Enabled with Reset-out)

The WDT is intended as a recovery method in situations where the CPU may be subjected to software upsets. The WDT consists of a 13-bit counter and the WatchDog Timer Reset (WDTRST) SFR. The WDT is defaulted to disable from exiting reset. To enable the WDT, a user must write 01EH and 0E1H in sequence to the WDTRST register (SFR location 0A6H). When the WDT is enabled, it will increment every machine cycle while the oscillator is running. The WDT time-out period is dependent on the external clock frequency. There is no way to disable the WDT except through reset (either hardware reset or WDT overflow reset). When WDT overflows, it will drive an output RESET HIGH pulse at the RST pin.

## 12. Timer 2

Timer 2 is a 16-bit Timer/Counter that can operate as either a timer or an event counter. The type of operation is selected by bit  $C/\overline{T}2$  in the SFR T2CON (shown in Table 5-2). Timer 2 has three operating modes: capture, auto-reload (up or down counting), and baud rate generator. The modes are selected by bits in T2CON, as shown in Table 5-2.

Timer 2 consists of two 8-bit registers, TH2 and TL2. In the Timer function, the TL2 register is incremented every machine cycle. Since a machine cycle consists of 12 oscillator periods, the count rate is 1/12 of the oscillator frequency.

**Table 12-1.** Timer 2 Operating Modes

RCLK +TCLK	CP/ $\overline{RL}2$	TR2	MODE
0	0	1	16-bit Auto-Reload
0	1	1	16-bit Capture
1	X	1	Baud Rate Generator
X	X	0	(Off)

In the Counter function, the register is incremented in response to a 1-to-0 transition at its corresponding external input pin, T2. In this function, the external input is sampled during S5P2 of every machine cycle. When the samples show a high in one cycle and a low in the next cycle, the count is incremented. The new count value appears in the register during S3P1 of the cycle following the one in which the transition was detected. Since two machine cycles (24 oscillator periods) are required to recognize a 1-to-0 transition, the maximum count rate is 1/24 of the oscillator frequency. To ensure that a given level is sampled at least once before it changes, the level should be held for at least one full machine cycle.

### 12.1 Capture Mode

In the capture mode, two options are selected by bit EXEN2 in T2CON. If EXEN2 = 0, Timer 2 is a 16-bit timer or counter which upon overflow sets bit TF2 in T2CON. This bit can then be used to generate an interrupt. If EXEN2 = 1, Timer 2 performs the same operation, but a 1-to-0 transition at external input T2EX also causes the current value in TH2 and TL2 to be captured into RCAP2H and RCAP2L, respectively. In addition, the transition at T2EX causes bit EXF2 in T2CON to be set. The EXF2 bit, like TF2, can generate an interrupt. The capture mode is illustrated in Figure 12-1.

### 12.2 Auto-reload (Up or Down Counter)

Timer 2 can be programmed to count up or down when configured in its 16-bit auto-reload mode. This feature is invoked by the DCEN (Down Counter Enable) bit located in the SFR T2MOD (see Table 12-2). Upon reset, the DCEN bit is set to 0 so that timer 2 will default to count up. When DCEN is set, Timer 2 can count up or down, depending on the value of the T2EX pin.

The diagram illustrates the internal components and signal flow of the Timer 2 peripheral. It starts with an oscillator (OSC) connected to a divider ( $\div 12$ ). The output of the divider is connected to a multiplexer controlled by  $C/\overline{T2} = 0$ , which selects the input to the timer counter (TH2/TL2). The timer counter is also connected to the overflow flag (TF2). The timer counter is also connected to a multiplexer controlled by  $C/\overline{T2} = 1$ , which selects the input to the capture registers (RCAP2H/RCAP2L). The capture registers are connected to the EXF2 register. The EXF2 register is connected to the interrupt logic (AND gate) which generates the TIMER 2 INTERRUPT signal. The interrupt logic also receives input from the overflow flag (TF2).

Setting the DCEN bit enables Timer 2 to count up or down, as shown in Figure 12-2. In this mode, the T2EX pin controls the direction of the count. A logic 1 at T2EX makes Timer 2 count up. The timer will overflow at 0FFFFH and set the TF2 bit. This overflow also causes the 16-bit value in RCAP2H and RCAP2L to be reloaded into the timer registers, TH2 and TL2, respectively.

The EXF2 bit toggles whenever Timer 2 overflows or underflows and can be used as a 17th bit of resolution. In this operating mode, EXF2 does not flag an interrupt.

## 16. Oscillator Characteristics

XTAL1 and XTAL2 are the input and output, respectively, of an inverting amplifier that can be configured for use as an on-chip oscillator, as shown in Figure 18-1. Either a quartz crystal or ceramic resonator may be used. To drive the device from an external clock source, XTAL2 should be left unconnected while XTAL1 is driven, as shown in Figure 18-2. There are no requirements on the duty cycle of the external clock signal, since the input to the internal clocking circuitry is through a divide-by-two flip-flop, but minimum and maximum voltage high and low time specifications must be observed.

## 17. Idle Mode

In idle mode, the CPU puts itself to sleep while all the on-chip peripherals remain active. The mode is invoked by software. The content of the on-chip RAM and all the special functions registers remain unchanged during this mode. The idle mode can be terminated by any enabled interrupt or by a hardware reset.

Note that when idle mode is terminated by a hardware reset, the device normally resumes program execution from where it left off, up to two machine cycles before the internal reset algorithm takes control. On-chip hardware inhibits access to internal RAM in this event, but access to the port pins is not inhibited. To eliminate the possibility of an unexpected write to a port pin when idle mode is terminated by a reset, the instruction following the one that invokes idle mode should not write to a port pin or to external memory.

## 18. Power-down Mode

In the Power-down mode, the oscillator is stopped, and the instruction that invokes Power-down is the last instruction executed. The on-chip RAM and Special Function Registers retain their values until the Power-down mode is terminated. Exit from Power-down can be initiated either by a hardware reset or by an enabled external interrupt. Reset redefines the SFRs but does not change the on-chip RAM. The reset should not be activated before  $V_{CC}$  is restored to its normal operating level and must be held active long enough to allow the oscillator to restart and stabilize.

**Chip Erase Sequence:** Before the AT89C55WD can be reprogrammed, a Chip Erase operation needs to be performed. To erase the contents of the AT89C55WD, follow this sequence:

1. Raise  $V_{CC}$  to 6.5V.
2. Pulse  $\overline{ALE}/\overline{PROG}$  once (duration of 200 - 500 ns).
3. Wait for 150 ms.
4. Power  $V_{CC}$  down and up to 6.5V.
5. Pulse  $\overline{ALE}/\overline{PROG}$  once (duration of 200 - 500 ns).
6. Wait for 150 ms.
7. Power  $V_{CC}$  down and up.

**Data Polling:** The AT89C55WD features  $\overline{Data}$  Polling to indicate the end of a write cycle. During a write cycle, an attempted read of the last byte written will result in the complement of the written data on P0.7. Once the write cycle has been completed, true data is valid on all outputs, and the next cycle may begin.  $\overline{Data}$  Polling may begin any time after a write cycle has been initiated.

**Ready/Busy:** The progress of byte programming can also be monitored by the  $\overline{RDY}/\overline{BSY}$  output signal. P3.0 is pulled low after  $\overline{ALE}$  goes high during programming to indicate  $\overline{BUSY}$ . P3.0 is pulled high again when programming is done to indicate  $\overline{READY}$ .

**Program Verify:** If lock bits LB1 and LB2 have not been programmed, the programmed code data can be read back via the address and data lines for verification. The status of the individual lock bits can be directly verified by reading them back.

**Reading the Signature Bytes:** The signature bytes are read by the same procedure as a normal verification of locations 000H, 100H, and 200H, except that P3.6 and P3.7 must be pulled to a logic low. The values returned are as follows:






- (000H) = 1EH indicates manufactured by Atmel
- (100H) = 55H
- (200H) = 06H indicates 89C55WD

## 21. Programming Interface

Every code byte in the Flash array can be programmed by using the appropriate combination of control signals. The write operation cycle is self-timed and once initiated, will automatically time itself to completion.

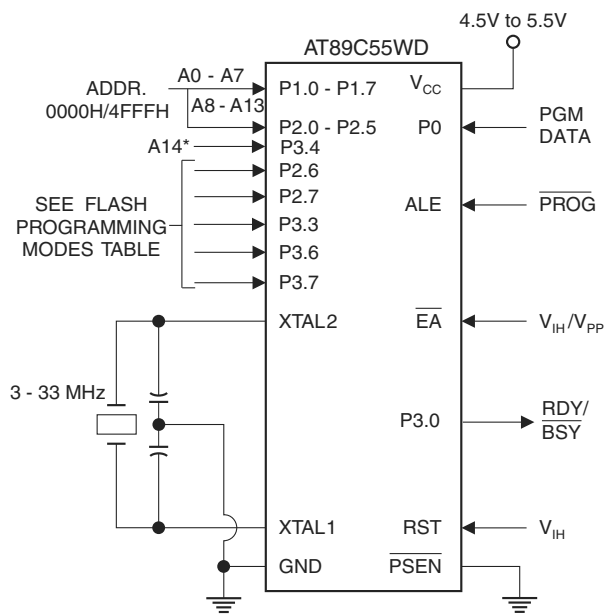
Most major worldwide programming vendors offer support for the Atmel AT89 microcontroller series. Please contact your local programming vendor for the appropriate software revision.

**Table 21-1. Flash Programming Modes**

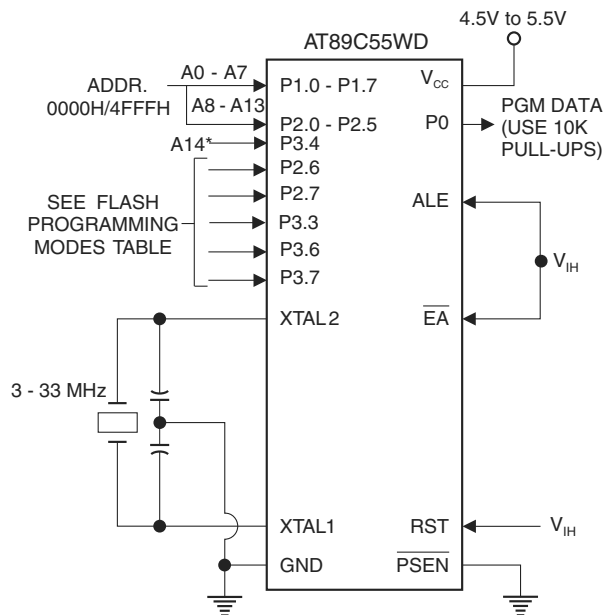
Mode	V <sub>CC</sub>	RST	PSEN	ALE/ PROG	EA/ V <sub>PP</sub>	P2.6	P2.7	P3.3	P3.6	P3.7	P0.7-0 Data	P3.4	P2.5-0	P1.7-0
												Address		
Write Code Data	5V	H	L	 <sup>(1)</sup>	12V	L	H	H	H	H	D <sub>IN</sub>	A14	A13-8	A7-0
Read Code Data	5V	H	L	H	H/12V	L	L	L	H	H	D <sub>OUT</sub>	A14	A13-8	A7-0
Write Lock Bit 1	6.5 V	H	L	 <sup>(2)</sup>	12V	H	H	H	H	H	X	X	X	X
Write Lock Bit 2	6.5 V	H	L	 <sup>(2)</sup>	12V	H	H	H	L	L	X	X	X	X
Write Lock Bit 3	6.5 V	H	L	 <sup>(2)</sup>	12V	H	L	H	H	L	X	X	X	X
Read Lock Bits 1, 2, 3	5V	H	L	H	H	H	H	L	H	L	P0.2, P0.3, P0.4	X	X	X
Chip Erase	6.5 V	H	L	 <sup>(3)</sup>	12V	H	L	H	L	L	X	X	X	X
Read Atmel ID	5V	H	L	H	H	L	L	L	L	L	1EH	X	XX 0000	00H
Read Device ID	5V	H	L	H	H	L	L	L	L	L	55H	X	XX 0001	00H
Read Device ID	5V	H	L	H	H	L	L	L	L	L	06H	X	XX 0010	00H

Notes: 1. Write Code Data requires a 200 ns PROG pulse.  
2. Write Lock Bits requires a 100  $\mu$ s PROG pulse.  
3. Chip Erase requires a 200 ns - 500 ns PROG pulse.  
4. RDY/BSY signal is output on P3.0 during programming.

**Figure 21-1.** Programming the Flash Memory



**Figure 21-2.** Verifying the Flash Memory



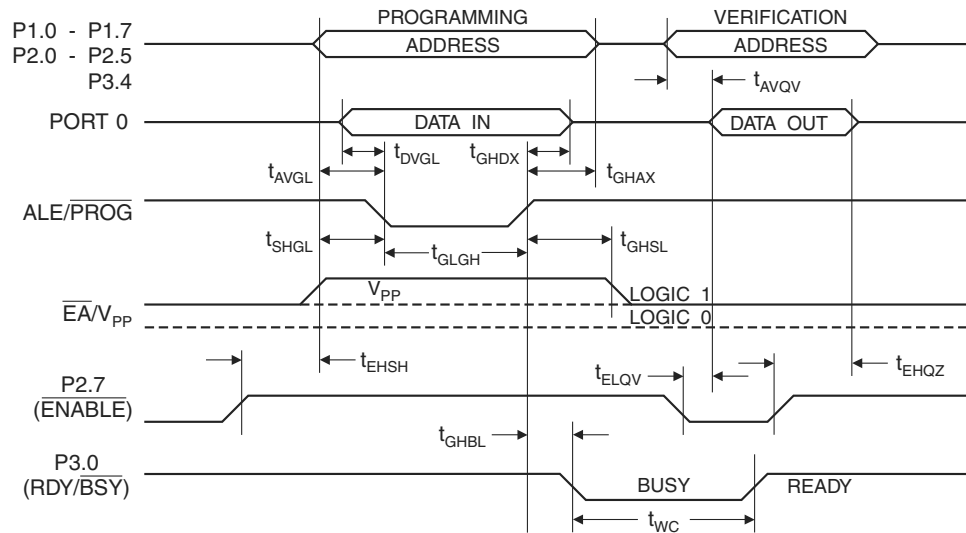
Note: \*Programming address line A14 (P3.4) is not the same as the external memory address line A14 (P2.6).

## 22. Flash Programming and Verification Characteristics

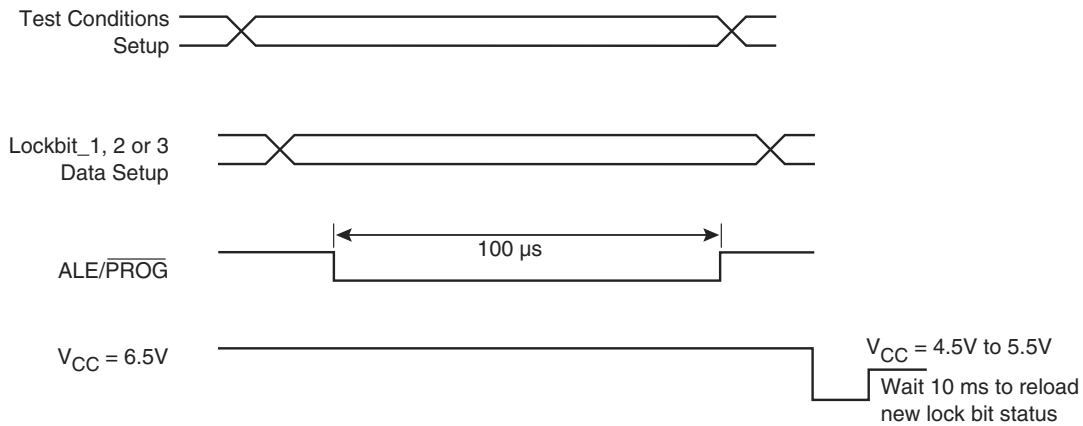
$T_A = 20^\circ\text{C}$  to  $30^\circ\text{C}$ ,  $V_{CC} = 4.5\text{V}$  to  $5.5\text{V}$

Symbol	Parameter	Min	Max	Units
$V_{PP}$	Programming Supply Voltage	11.5	12.5	V
$I_{PP}$	Programming Supply Current		10	mA
$I_{CC}$	$V_{CC}$ Supply Current		30	mA
$1/t_{CLCL}$	Oscillator Frequency	3	33	MHz
$t_{AVGL}$	Address Setup to $\overline{PROG}$ Low	$48t_{CLCL}$		
$t_{GHAX}$	Address Hold After $\overline{PROG}$	$48t_{CLCL}$		
$t_{DVGL}$	Data Setup to $\overline{PROG}$ Low	$48t_{CLCL}$		
$t_{GHDX}$	Data Hold After $\overline{PROG}$	$48t_{CLCL}$		
$t_{EHS}$	P2.7 ( $\overline{ENABLE}$ ) High to $V_{PP}$	$48t_{CLCL}$		
$t_{SHGL}$	$V_{PP}$ Setup to $\overline{PROG}$ Low	10		$\mu\text{s}$
$t_{GHSL}$	$V_{PP}$ Hold After $\overline{PROG}$	10		$\mu\text{s}$
$t_{GLGH}$	$\overline{PROG}$ Width	0.2	1	$\mu\text{s}$
$t_{AVQV}$	Address to Data Valid		$48t_{CLCL}$	
$t_{ELQV}$	$\overline{ENABLE}$ Low to Data Valid		$48t_{CLCL}$	
$t_{EHQZ}$	Data Float After $\overline{ENABLE}$	0	$48t_{CLCL}$	
$t_{GHBL}$	$\overline{PROG}$ High to $\overline{BUSY}$ Low		1.0	$\mu\text{s}$
$t_{WC}$	Byte Write Cycle Time		80	$\mu\text{s}$

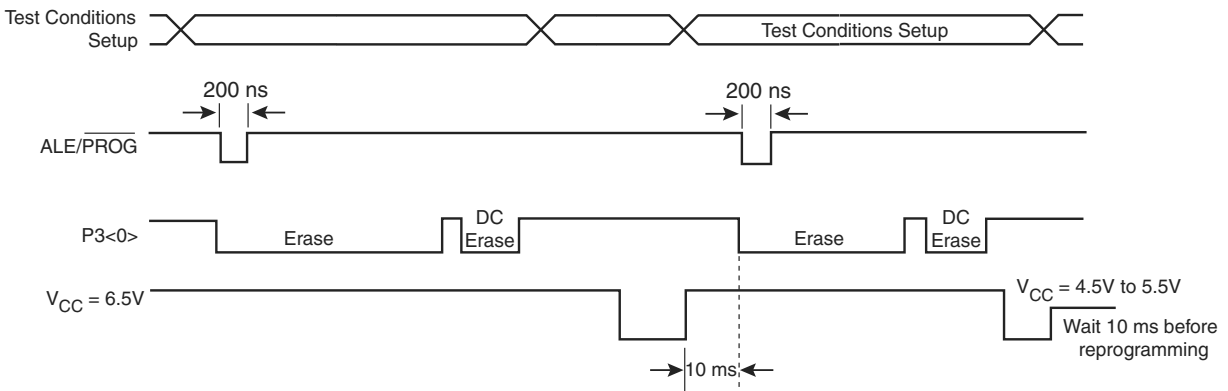
## 23. Flash Programming and Verification Waveforms



## 24. Lock Bit Programming



## 25. Parallel Chip Erase Mode



## 26. Absolute Maximum Ratings\*

Operating Temperature.....	-55°C to +125°C
Storage Temperature .....	-65°C to +150°C
Voltage on Any Pin with Respect to Ground .....	-1.0V to +7.0V
Maximum Operating Voltage .....	6.6V
DC Output Current.....	15.0 mA

**\*NOTICE:** Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## 27. DC Characteristics

The values shown in this table are valid for  $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$  and  $V_{CC} = 4.0\text{V}$  to  $5.5\text{V}$ , unless otherwise noted.

Symbol	Parameter	Condition	Min	Max	Units
$V_{IL}$	Input Low Voltage	(Except $\overline{EA}$ )	-0.5	$0.2 V_{CC}-0.1$	V
$V_{IL1}$	Input Low Voltage ( $\overline{EA}$ )		-0.5	$0.2 V_{CC}-0.3$	V
$V_{IH}$	Input High Voltage	(Except XTAL1, RST)	$0.2 V_{CC}+0.9$	$V_{CC}+0.5$	V
$V_{IH1}$	Input High Voltage	(XTAL1, RST)	$0.7 V_{CC}$	$V_{CC}+0.5$	V
$V_{OL}$	Output Low Voltage <sup>(1)</sup> (Ports 1,2,3)	$I_{OL} = 1.6 \text{ mA}$		0.45	V
$V_{OL1}$	Output Low Voltage <sup>(1)</sup> (Port 0, ALE, $\overline{PSEN}$ )	$I_{OL} = 3.2 \text{ mA}$		0.45	V
$V_{OH}$	Output High Voltage (Ports 1,2,3, ALE, $\overline{PSEN}$ )	$I_{OH} = -60 \mu\text{A}$ , $V_{CC} = 5\text{V} \pm 10\%$	2.4		V
		$I_{OH} = -25 \mu\text{A}$	$0.75 V_{CC}$		V
		$I_{OH} = -10 \mu\text{A}$	$0.9 V_{CC}$		V
$V_{OH1}$	Output High Voltage (Port 0 in External Bus Mode)	$I_{OH} = -800 \mu\text{A}$ , $V_{CC} = 5\text{V} \pm 10\%$	2.4		V
		$I_{OH} = -300 \mu\text{A}$	$0.75 V_{CC}$		V
		$I_{OH} = -80 \mu\text{A}$	$0.9 V_{CC}$		V
$I_{IL}$	Logical 0 Input Current (Ports 1,2,3)	$V_{IN} = 0.45\text{V}$		-50	$\mu\text{A}$
$I_{TL}$	Logical 1 to 0 Transition Current (Ports 1,2,3)	$V_{IN} = 2\text{V}$ , $V_{CC} = 5\text{V} \pm 10\%$		-650	$\mu\text{A}$
$I_{LI}$	Input Leakage Current (Port 0, $\overline{EA}$ )	$0.45 < V_{IN} < V_{CC}$		$\pm 10$	$\mu\text{A}$
RRST	Reset Pulldown Resistor		10	30	$\text{k}\Omega$
$C_{IO}$	Pin Capacitance	Test Freq. = 1 MHz, $T_A = 25^{\circ}\text{C}$		10	pF
$I_{CC}$	Power Supply Current	Active Mode, 12 MHz		25	mA
		Idle Mode, 12 MHz		6.5	mA
	Power-down Mode <sup>(1)</sup>	$V_{CC} = 5.5\text{V}$		100	$\mu\text{A}$

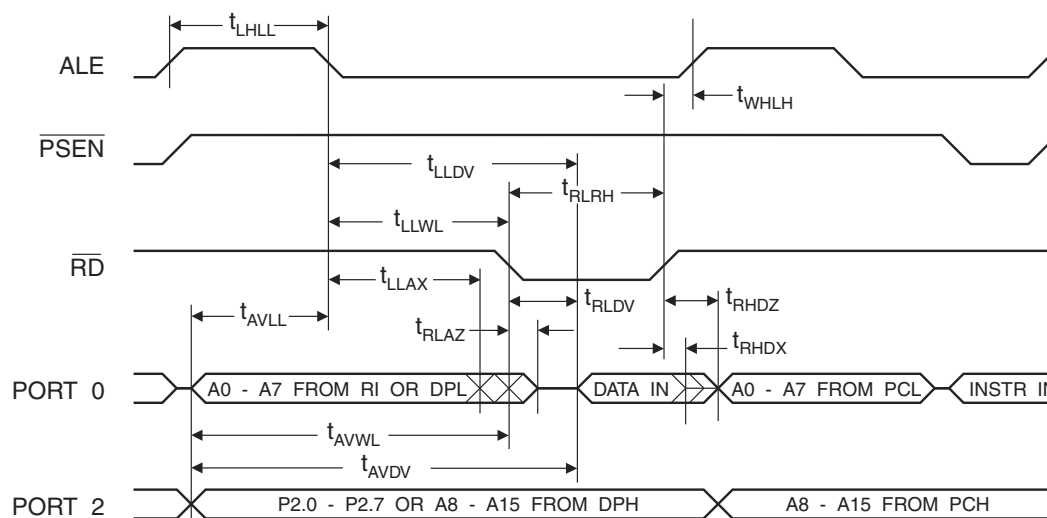
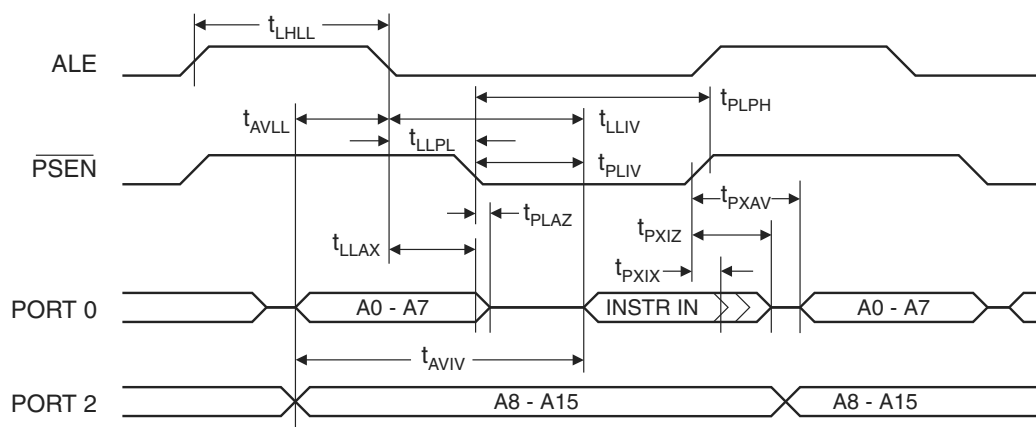
- Notes: 1. Under steady state (non-transient) conditions,  $I_{OL}$  must be externally limited as follows:  
Maximum  $I_{OL}$  per port pin: 10 mA  
Maximum  $I_{OL}$  per 8-bit port:  
Port 0: 26 mA      Ports 1, 2, 3: 15 mA  
Maximum total  $I_{OL}$  for all output pins: 71 mA  
If  $I_{OL}$  exceeds the test condition,  $V_{OL}$  may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.
2. Minimum  $V_{CC}$  for Power-down is 2V.

## 28. AC Characteristics

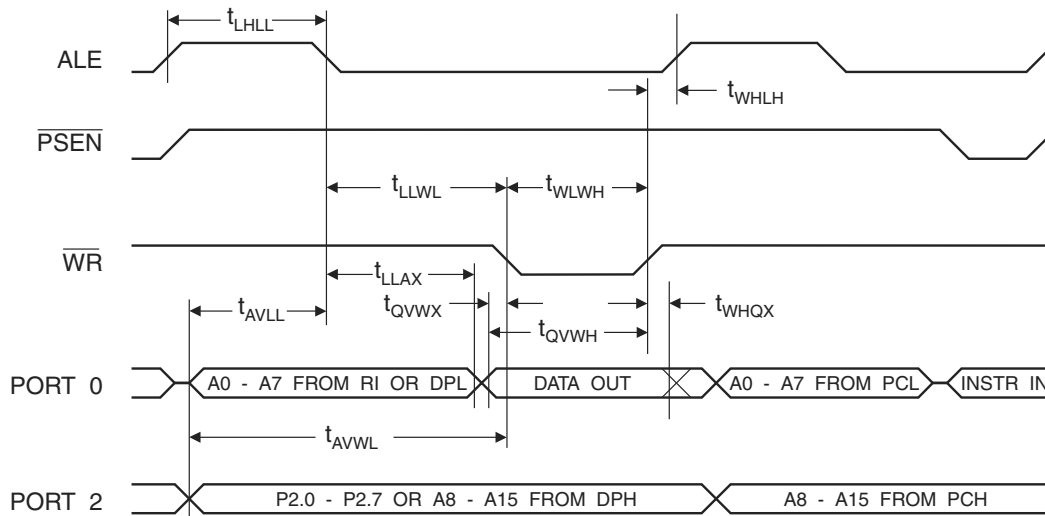
Under operating conditions, load capacitance for Port 0, ALE/ $\overline{\text{PROG}}$ , and  $\overline{\text{PSEN}}$  = 100 pF; load capacitance for all other outputs = 80 pF.

### 28.1 External Program and Data Memory Characteristics

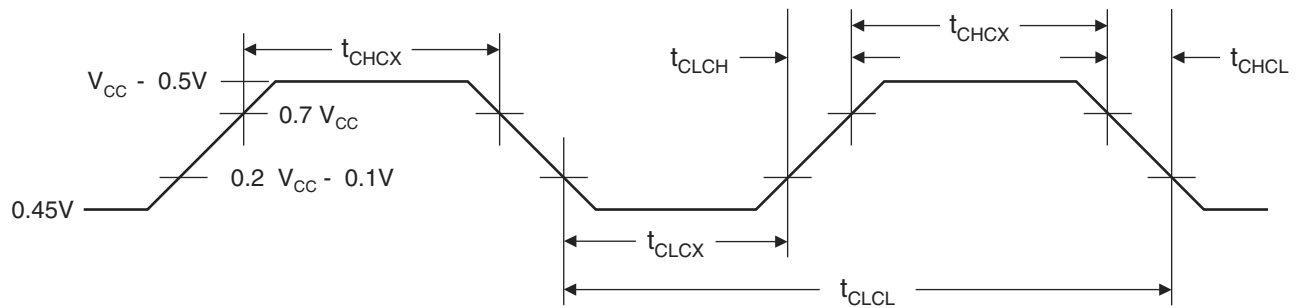
Symbol	Parameter	12 MHz Oscillator		Variable Oscillator		Units
		Min	Max	Min	Max	
$1/t_{\text{CLCL}}$	Oscillator Frequency			0	33	MHz
$t_{\text{LHLL}}$	ALE Pulse Width	127		$2t_{\text{CLCL}}-40$		ns
$t_{\text{AVLL}}$	Address Valid to ALE Low	43		$t_{\text{CLCL}}-25$		ns
$t_{\text{LLAX}}$	Address Hold After ALE Low	48		$t_{\text{CLCL}}-25$		ns
$t_{\text{LLIV}}$	ALE Low to Valid Instruction In		233		$4t_{\text{CLCL}}-65$	ns
$t_{\text{LLPL}}$	ALE Low to $\overline{\text{PSEN}}$ Low	43		$t_{\text{CLCL}}-25$		ns
$t_{\text{PLPH}}$	$\overline{\text{PSEN}}$ Pulse Width	205		$3t_{\text{CLCL}}-45$		ns
$t_{\text{PLIV}}$	$\overline{\text{PSEN}}$ Low to Valid Instruction In		145		$3t_{\text{CLCL}}-60$	ns
$t_{\text{PXIX}}$	Input Instruction Hold After $\overline{\text{PSEN}}$	0		0		ns
$t_{\text{PXIZ}}$	Input Instruction Float After $\overline{\text{PSEN}}$		59		$t_{\text{CLCL}}-25$	ns
$t_{\text{PXAV}}$	$\overline{\text{PSEN}}$ to Address Valid	75		$t_{\text{CLCL}}-8$		ns
$t_{\text{AVIV}}$	Address to Valid Instruction In		312		$5t_{\text{CLCL}}-80$	ns
$t_{\text{PLAZ}}$	$\overline{\text{PSEN}}$ Low to Address Float		10		10	ns
$t_{\text{RLRH}}$	$\overline{\text{RD}}$ Pulse Width	400		$6t_{\text{CLCL}}-100$		ns
$t_{\text{WLWH}}$	$\overline{\text{WR}}$ Pulse Width	400		$6t_{\text{CLCL}}-100$		ns
$t_{\text{RLDV}}$	$\overline{\text{RD}}$ Low to Valid Data In		252		$5t_{\text{CLCL}}-90$	ns
$t_{\text{RHDX}}$	Data Hold After $\overline{\text{RD}}$	0		0		ns
$t_{\text{RHDZ}}$	Data Float After $\overline{\text{RD}}$		97		$2t_{\text{CLCL}}-28$	ns
$t_{\text{LLDV}}$	ALE Low to Valid Data In		517		$8t_{\text{CLCL}}-150$	ns
$t_{\text{AVDV}}$	Address to Valid Data In		585		$9t_{\text{CLCL}}-165$	ns
$t_{\text{LLWL}}$	ALE Low to $\overline{\text{RD}}$ or $\overline{\text{WR}}$ Low	200	300	$3t_{\text{CLCL}}-50$	$3t_{\text{CLCL}}+50$	ns
$t_{\text{AVWL}}$	Address to $\overline{\text{RD}}$ or $\overline{\text{WR}}$ Low	203		$4t_{\text{CLCL}}-75$		ns
$t_{\text{QVWX}}$	Data Valid to $\overline{\text{WR}}$ Transition	23		$t_{\text{CLCL}}-30$		ns
$t_{\text{QVWH}}$	Data Valid to $\overline{\text{WR}}$ High	433		$7t_{\text{CLCL}}-130$		ns
$t_{\text{WHQX}}$	Data Hold After $\overline{\text{WR}}$	33		$t_{\text{CLCL}}-25$		ns
$t_{\text{RLAZ}}$	$\overline{\text{RD}}$ Low to Address Float		0		0	ns
$t_{\text{WHLH}}$	$\overline{\text{RD}}$ or $\overline{\text{WR}}$ High to ALE High	43	123	$t_{\text{CLCL}}-25$	$t_{\text{CLCL}}+25$	ns



### 31. External Data Memory Write Cycle



### 32. External Clock Drive Waveforms



### 33. External Clock Drive

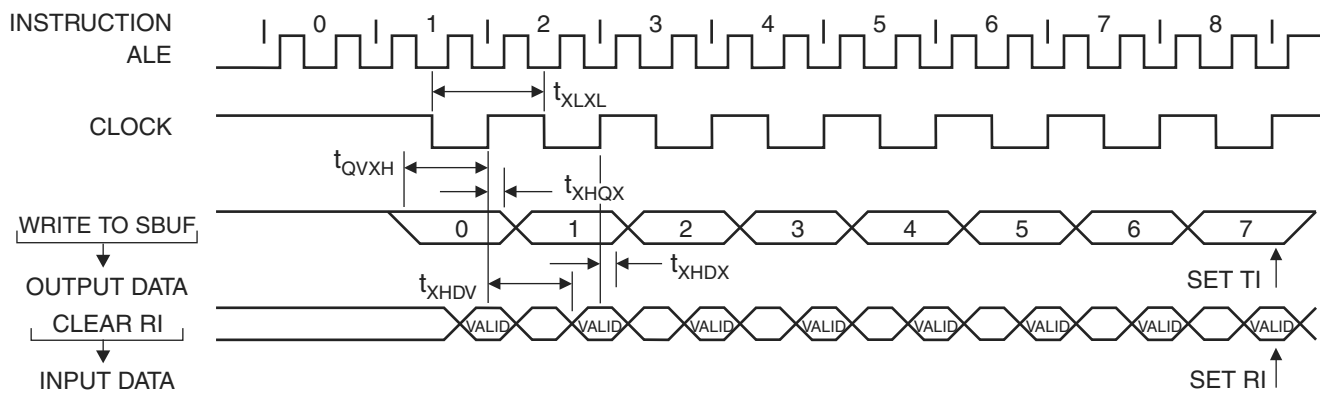
Symbol	Parameter	Min	Max	Units
$1/t_{CLCL}$	Oscillator Frequency	0	33	MHz
$t_{CLCL}$	Clock Period	30		ns
$t_{CHCX}$	High Time	12		ns
$t_{CLCX}$	Low Time	12		ns
$t_{CLCH}$	Rise Time		5	ns
$t_{CHCL}$	Fall Time		5	ns

## 34. Serial Port Timing: Shift Register Mode Test Conditions

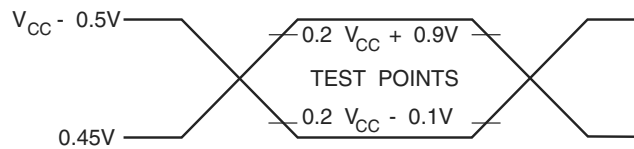
The values in this table are valid for  $V_{CC} = 4.0V$  to  $5.5V$  and Load Capacitance =  $80\text{ pF}$ .

Symbol	Parameter	12 MHz Osc		Variable Oscillator		Units
		Min	Max	Min	Max	
$t_{XLXL}$	Serial Port Clock Cycle Time	1.0		$12t_{CLCL}$		$\mu s$
$t_{QVXH}$	Output Data Setup to Clock Rising Edge	700		$10t_{CLCL}-133$		ns
$t_{XHGX}$	Output Data Hold After Clock Rising Edge	50		$2t_{CLCL}-80$		ns
$t_{XHDX}$	Input Data Hold After Clock Rising Edge	0		0		ns
$t_{XHDV}$	Clock Rising Edge to Input Data Valid		700		$10t_{CLCL}-133$	ns

## 35. Shift Register Mode Timing Waveforms

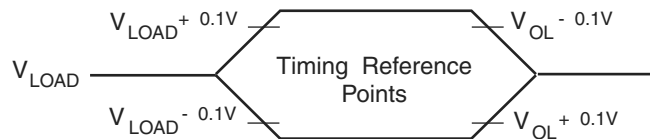


## 36. AC Testing Input/Output Waveforms<sup>(1)</sup>



Note: 1. AC Inputs during testing are driven at  $V_{CC} - 0.5V$  for a logic 1 and  $0.45V$  for a logic 0. Timing measurements are made at  $V_{IH}$  min. for a logic 1 and  $V_{IL}$  max. for a logic 0.

## 37. Float Waveforms<sup>(1)</sup>



Note: 1. For timing purposes, a port pin is no longer floating when a  $100\text{ mV}$  change from load voltage occurs. A port pin begins to float when a  $100\text{ mV}$  change from the loaded  $V_{OH}/V_{OL}$  level occurs.

## 38. Ordering Information

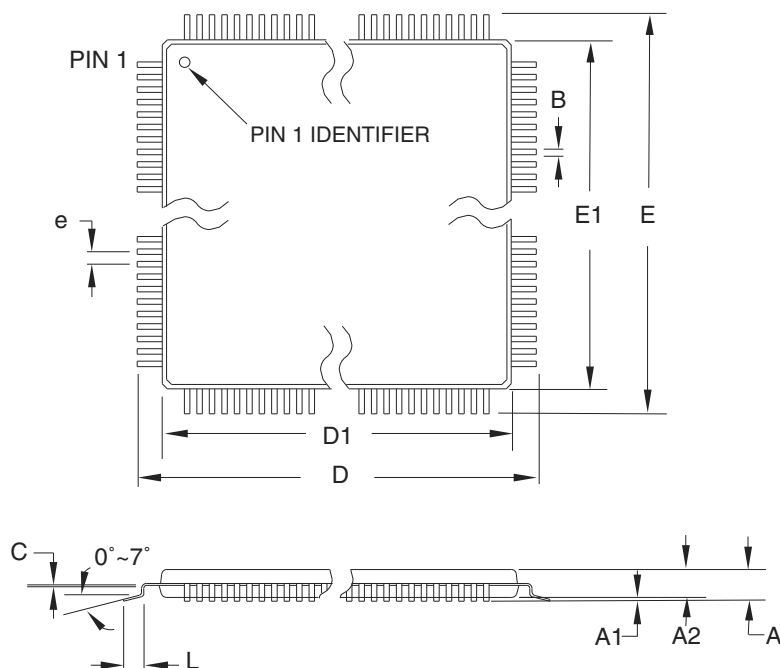
### 38.1 Green Package Option (Pb/Halide-free)

Speed (MHz)	Power Supply	Ordering Code	Package	Operation Range
24	4.0V to 5.5V	AT89C55WD-24AU AT89C55WD-24JU AT89C55WD-24PU	44A 44J 40P6	Industrial (-40° C to 85° C)
33	4.5V to 5.5V	AT89C55WD-33AU AT89C55WD-33JU AT89C55WD-33PU	44A 44J 40P6	Industrial (-40° C to 85° C)

Package Type	
<b>44A</b>	44-lead, Thin Plastic Gull Wing Quad Flatpack (TQFP)
<b>44J</b>	44-lead, Plastic J-leaded Chip Carrier (PLCC)
<b>40P6</b>	40-pin, 0.600" Wide, Plastic Dual Inline Package (PDIP)

## 39. Package Information

### 39.1 44A – TQFP



**COMMON DIMENSIONS**  
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.20	
A1	0.05	–	0.15	
A2	0.95	1.00	1.05	
D	11.75	12.00	12.25	
D1	9.90	10.00	10.10	Note 2
E	11.75	12.00	12.25	
E1	9.90	10.00	10.10	Note 2
B	0.30	–	0.45	
C	0.09	–	0.20	
L	0.45	–	0.75	
e	0.80 TYP			

- Notes:
1. This package conforms to JEDEC reference MS-026, Variation ACB.
  2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25 mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
  3. Lead coplanarity is 0.10 mm maximum.

10/5/2001

2325 Orchard Parkway San Jose, CA 95131	<b>TITLE</b>	<b>DRAWING NO.</b>	<b>REV.</b>
	<b>44A</b> , 44-lead, 10 x 10 mm Body Size, 1.0 mm Body Thickness, 0.8 mm Lead Pitch, Thin Profile Plastic Quad Flat Package (TQFP)	44A	B